

Sector

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

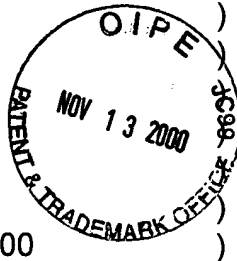
In re Application of

Takashi AKAHORI

Serial No.: 09/660,884

Filed: September 12, 2000

For: SEMICONDUCTOR DEVICE



Group Art Unit:

Examiner:

Assistant Commissioner for Patents

Washington, D.C. 20231

Attention:

BOX MISSING PART

Sir:

RESPONSE TO NOTICE TO FILE MISSING PARTS

In response to the Notice To File Missing Parts dated October 26, 2000, enclosed is the literal translation of the above-identified patent application which was filed on September 12, 2000, in accordance with §608.01 of the MPEP, Filing of Non-English Language Applications. Also enclosed is a verification by the translator testifying to the accuracy of the translation. Also enclosed is a check in the amount of \$472.00 to cover the surcharge fee for filing the English-language translation late (\$130.00), extra claims fee (\$72.00) and multiple dependent claims fee (\$270.00).

Please associate this translation with the application as filed on September 12, 2000 and assigned serial number 09/660,884.

LAW OFFICES

FINNEGAN, HENDERSON,
FARABOW, GARRETT,
& DUNNER, L.L.P.
1300 I STREET, N. W.
WASHINGTON, DC 20005
202-406-4000

Authorization is hereby given to charge any additional fees associated with
this matter to our deposit account no. 06-0916.

Respectfully submitted,

FINNEGAN, HENDERSON, FARABOW,
GARRETT & DUNNER, L.L.P.

By: 

David W. Hill
Reg. No. 28,220

Dated: November 13, 2000

DWH/FPD/rgm
Enclosures



UNITED STATES PATENT AND TRADEMARK OFFICE

COMMISSIONER FOR PATENTS
UNITED STATES PATENT AND TRADEMARK OFFICE
WASHINGTON, D.C. 20231
www.uspto.gov

| APPLICATION NUMBER | FILING/RECEIPT DATE | FIRST NAMED APPLICANT | ATTORNEY DOCKET NUMBER |
|--------------------|---------------------|-----------------------|------------------------|
| 09/660,884 | 09/12/2000 | Takashi Akahori | 08038.0038 |

Finnegan Henderson Farabow Garrett & Dunner LLP
1300 I Street NW
Washington, DC 20005-3315



FORMALITIES LETTER



OC000000005509132

Date Mailed: 10/26/2000

NOTICE TO FILE MISSING PARTS OF NONPROVISIONAL APPLICATION

FILED UNDER 37 CFR 1.53(b)

Filing Date Granted

An application number and filing date have been accorded to this application. The item(s) indicated below, however, are missing. Applicant is given TWO MONTHS from the date of this Notice within which to file all required items and pay any fees required below to avoid abandonment. Extensions of time may be obtained by filing a petition accompanied by the extension fee under the provisions of 37 CFR 1.136(a).

- The application was filed in a language other than English.
- Applicant must file an English translation of the application, the \$ 130 fee set forth in 37 CFR 1.17(k), unless previously submitted, and a statement that the translation is accurate (37 CFR 1.52(d)).
- Because your specification was filed in a language other than English, the Office was unable to determine the number of claims submitted. Additional claim fees may be due once the number of claims can be determined.
- The balance due by applicant is \$ 130.

A copy of this notice MUST be returned with the reply.


Customer Service Center

Initial Patent Examination Division (703) 308-1202

PART 2 - COPY TO BE RETURNED WITH RESPONSE

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| | |
|-----------|-----------|
| 01 FC:139 | 130.00 OP |
| 02 FC:104 | 270.00 OP |
| 03 FC:103 | 72.00 OP |

DECLARATION



In the matter of U.S. Patent
Application " Semiconductor
Device" in the name of Takashi
AKAHORI

I, Kensuke MIYAKOSHI, of Kyowa Patent and Law Office,
2-3, Marunouchi 3-Chome, Chiyoda-Ku, Tokyo-To, Japan,
declare and say:

that I am thoroughly conversant with both the Japanese
and English languages; and,

that the attached document represents a true English
translation of United States Patent Application
" Semiconductor Device" filed on September 12, 2000.

I further declare that all statements made herein of
my own knowledge are true and that all statements made on
information and belief are believed to be true; and further
that these statements were made with the knowledge that
willful false statements and the like so made are punishable
by fine or imprisonment, or both, under Section 1001 of Title
18 of the United States Code, and that such willful false
statements may jeopardize the validity of the application
or any patent issued thereon.

Dated: November 7, 2000

Kensuke Miyakoshi
Kensuke MIYAKOSHI

002150-4309960